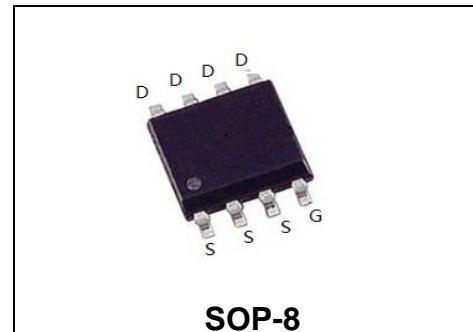
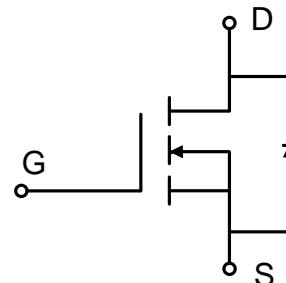


Features

- $R_{DS(on)}=13m\Omega$ (typ.) @ $V_{GS}=10V$
- 100% UIS tested
- Reliable and Rugged
- RoHS compliant



Type	Package	Marking
WMS11N06T1	SOP-8	WMS11N06T1



Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DSS}	60	V
Continuous drain current ($T_C = 25^\circ C$) ($T_C = 70^\circ C$)	I_D	11 8.2	A A
Pulsed drain current ¹⁾	I_{DM}	44	A
Gate-source voltage	V_{GS}	± 20	V
Avalanche energy, single pulse ²⁾	E_{AS}	84	mJ
Power dissipation ($T_C = 25^\circ C$) ($T_C = 70^\circ C$)	P_D	3.5 2.4	W W
Operating and storage temperature range	T_J, T_{STG}	-55 to +175	°C
Continuous diode forward current	I_S	11	A
Diode pulse current	$I_{S,pulse}$	44	A

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal resistance, junction-to-case	$R_{\theta JC}$	43	°C/W
Thermal resistance, junction-to-ambient	$R_{\theta JA}$	75	°C/W

Electrical Characteristics $T_c = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{\text{GS}}=0 \text{ V}, I_{\text{D}}=0.25 \text{ mA}$	60	-	-	V
Gate threshold voltage	$V_{\text{GS}(\text{th})}^{3)}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=0.25 \text{ mA}$	1	2	3	V
Drain cut-off current	I_{DSS}	$V_{\text{DS}}=60 \text{ V}, V_{\text{GS}}=0 \text{ V},$ $T_j = 25^\circ\text{C}$ $T_j = 85^\circ\text{C}$	-	-	1	μA
Gate leakage current, forward	I_{GSSF}	$V_{\text{GS}}=20 \text{ V}, V_{\text{DS}}=0 \text{ V}$	-	-	100	nA
Gate leakage current, reverse	I_{GSSR}	$V_{\text{GS}}=-20 \text{ V}, V_{\text{DS}}=0 \text{ V}$	-	-	-100	nA
Drain-source on-state resistance	$R_{\text{DS}(\text{on})}^{3)}$	$V_{\text{GS}}=10 \text{ V}, I_{\text{D}}=11 \text{ A}$	-	13	15	$\text{m}\Omega$
		$V_{\text{GS}}=4.5 \text{ V}, I_{\text{D}}=8 \text{ A}$	-	13.5	17	
Gate resistance	R_{G}	f=1 MHz, open drain	-	1	-	Ω
Dynamic characteristics						
Input capacitance	C_{iss}	$V_{\text{DS}}=25 \text{ V}, V_{\text{GS}}=0 \text{ V},$ $f = 1 \text{ MHz}$	-	2286	-	pF
Output capacitance	C_{oss}		-	188	-	
Reverse transfer capacitance	C_{rss}		-	142	-	
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 30 \text{ V}, I_{\text{D}} = 11 \text{ A}$ $R_{\text{G}} = 6 \Omega, V_{\text{GS}} = 10 \text{ V}$	-	8	-	ns
Rise time	t_r		-	4	-	
Turn-off delay time	$t_{\text{d}(\text{off})}$		-	27	-	
Fall time	t_f		-	3	-	
Gate charge characteristics						
Gate to source charge	Q_{gs}	$V_{\text{DD}} = 48 \text{ V}, I_{\text{D}} = 11 \text{ A},$ $V_{\text{GS}} = 0 \text{ to } 10 \text{ V}$	-	6.4	-	nC
Gate to drain charge	Q_{gd}		-	15.3	-	
Gate charge total	Q_{g}		-	52.5	-	
Reverse diode characteristics						
Diode forward voltage	$V_{\text{SD}}^{3)}$	$V_{\text{GS}}=0 \text{ V}, I_{\text{F}}=1 \text{ A}$	-	0.7	1.0	V
Reverse recovery time	t_{rr}	$I_{\text{F}}=11 \text{ A}, dI_{\text{F}}/dt=100 \text{ A}/\mu\text{s}$	-	15	-	ns
Reverse recovery charge	Q_{rr}		-	55	-	μC

Notes:

1. Repetitive rating: pulse width limited by maximum junction temperature
2. L=0.5mH, $V_{\text{DD}}=48 \text{ V}$, starting $T_j = 25^\circ\text{C}$
3. Pulse test: pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.

Electrical Characteristics Diagrams

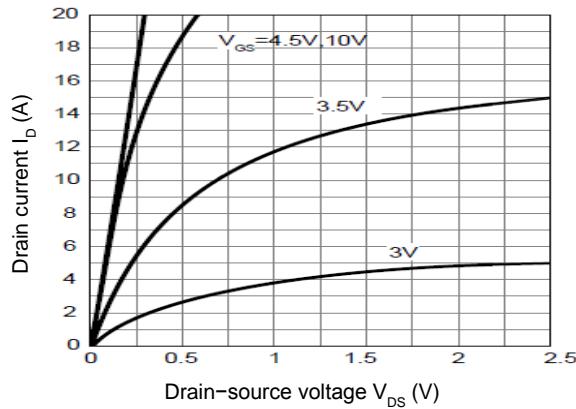


Figure 1. On-Region Characteristics

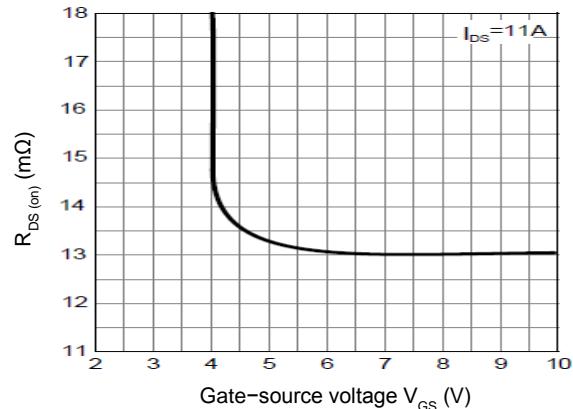


Figure 2. On-Resistance Variation vs. Threshold Voltage

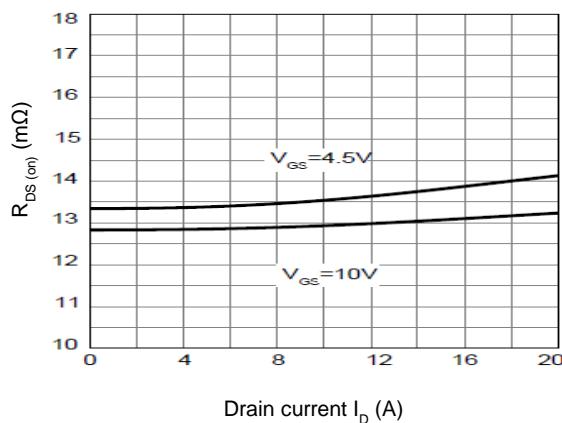


Figure 3. On-Resistance Variation vs. Drain Current

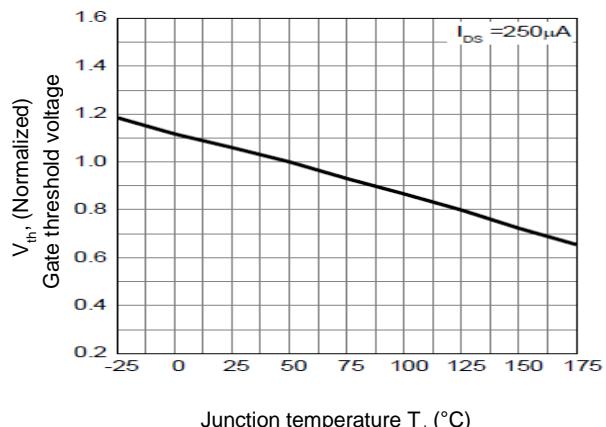


Figure 4. Threshold Voltage Variation vs. Temperature

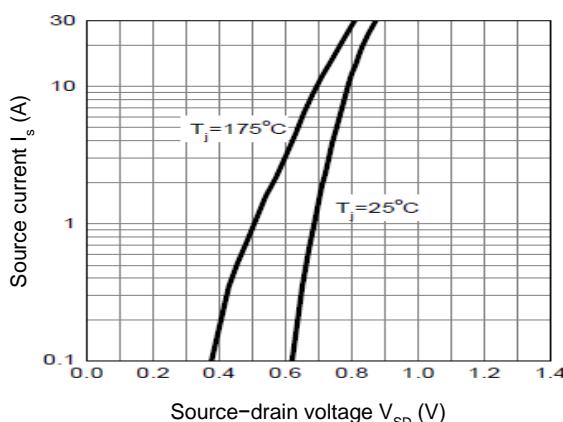


Figure 5. Source Current Variation vs. Source-drain Voltage

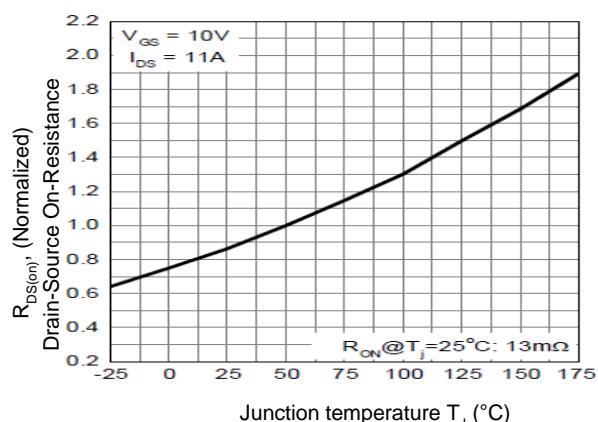


Figure 6. On-Resistance vs. Temperature

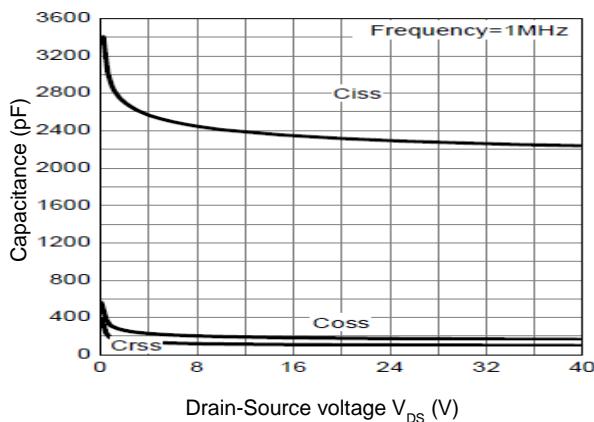


Figure 7. Capacitance Characteristics

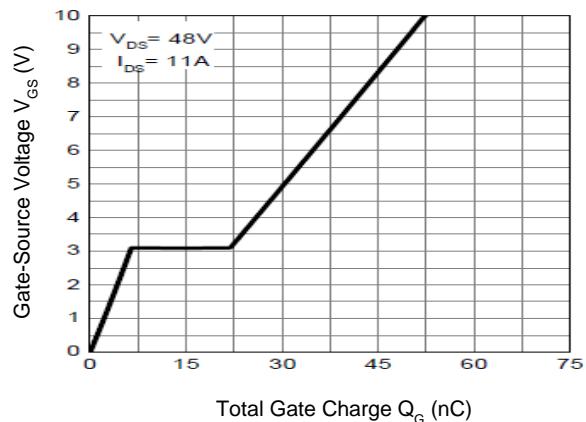


Figure 8. Gate Charge Characteristics

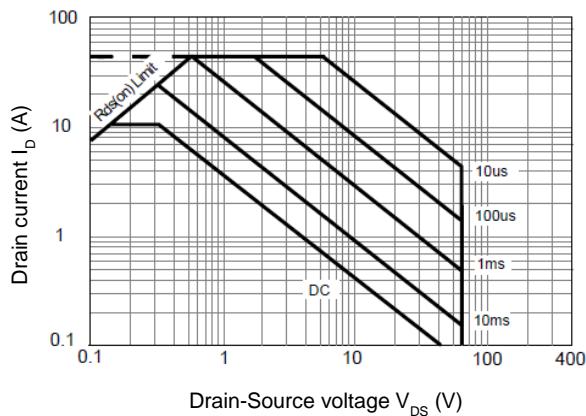


Figure 9. Maximum Safe Operating Area

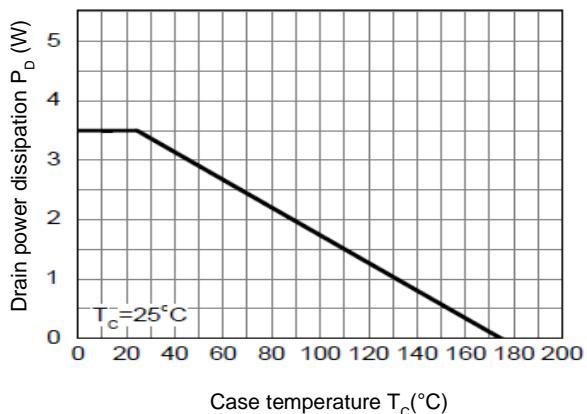


Figure 10. Power Dissipation vs. Case Temperature

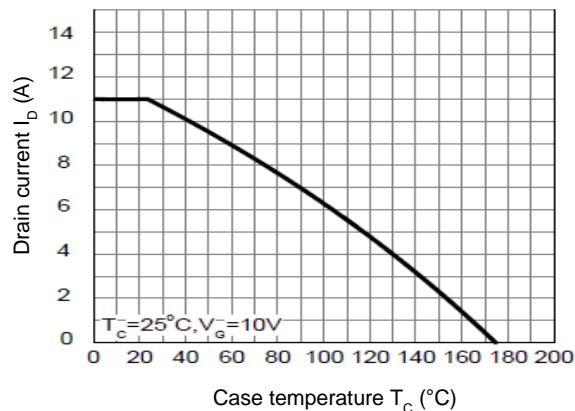


Figure 11. Drain Current vs. Case Temperature

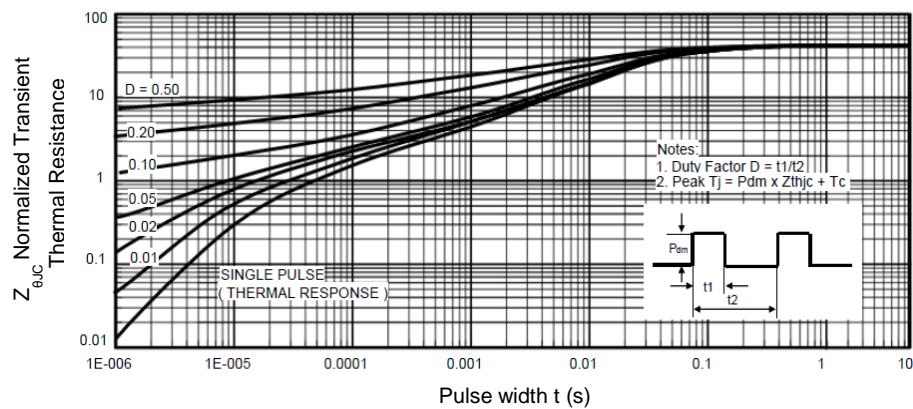
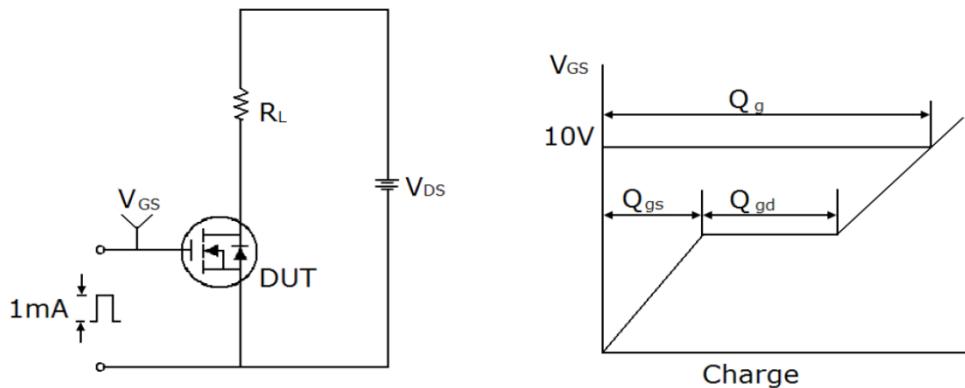
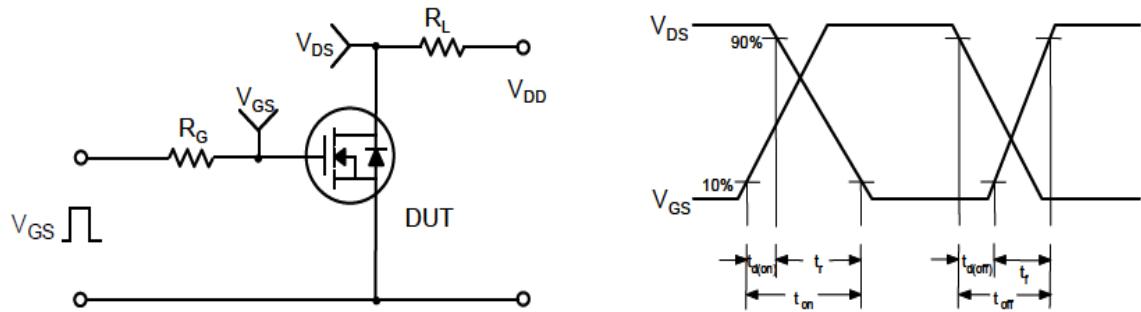
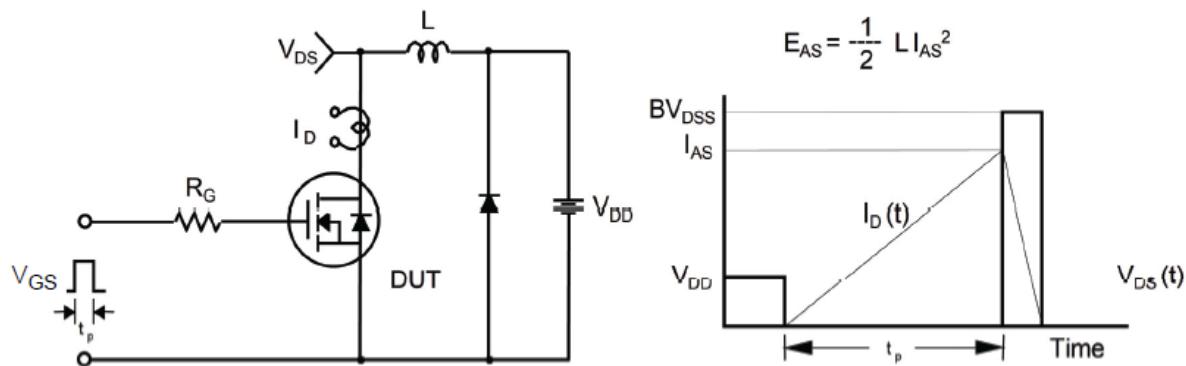


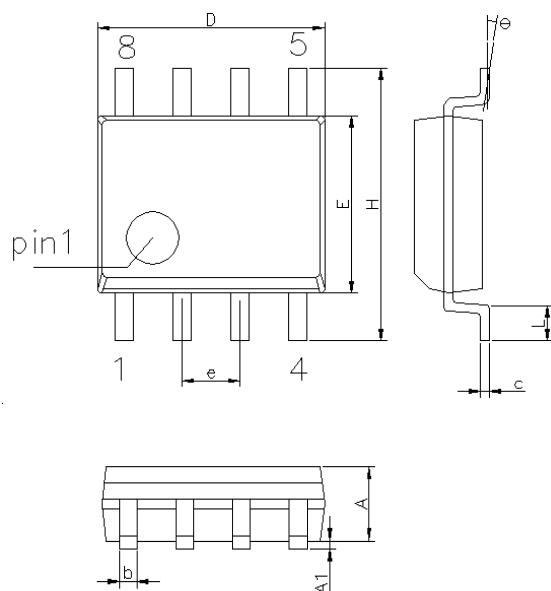
Figure 12. Transient Thermal Response Curve

Gate Charge Test Circuit & Waveform**Switching Test Circuit & Waveforms**

Unclamped Inductive Switching Test Circuit & Waveforms



Mechanical Dimensions for SOP-8



COMMON DIMENSIONS

SYMBOL	MM	
	MIN	MAX
A	1.40	1.60
A1	0.10	0.25
b	0.35	0.50
c	0.19	0.27
D	4.80	5.00
E	3.80	4.00
e	1.22	1.32
H	5.80	6.20
L	0.60	0.90
θ	0°	8°

Ordering Information

Part	Package	Marking	Packing method	Quantity
WMS11N06T1	SOP-8	WMS11N06T1	Tape and Reel	2500

Contact Information

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WAYON website: <http://www.way-on.com>

For additional information, please contact your local Sales Representative.

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